

Call for Papers

11th IEEE/ACM International Symposium on Networks-on-Chip October 19 – 20, 2017

Seoul, South Korea

(Co-located with Embedded Systems Week 2017)

The International Symposium on Networks-on-Chip (NOCS) is the premier event dedicated to interdisciplinary research on on-chip, chip-scale, and multichip package scale communication technology, architecture, design methods, applications and systems. NOCS brings together scientists and engineers working on NoC innovations and applications from inter-related research communities, including computer architecture, networking, circuits and systems, packaging, embedded systems, and design automation. Topics of interest include, but are not limited to:

NoC Architecture and Implementation

Network architecture (topology, routing, arbitration) NoC Quality of Service

Timing, synchronous/asynchronous communication NoC reliability issues

Network interface issues

NoC design methodologies and tools

Signaling & circuit design for NoC links

NoC Analysis and Verification

Power, energy & thermal issues (at the NoC, un-core and/or system-level)

Benchmarking & experience with NoC-based pardware

Modeling, simulation, and synthesis of NoCs Verification, debug & test of NoCs Metrics and benchmarks for NoCs

Novel NoC Technologies

New physical interconnect technologies, e.g., carbon nanotubes, wireless NoCs, through-silicon, etc.

NoCs for 3D and 2.5D packages

Package-specific NoC design

Optical, RF, & emerging technologies for on-chip/in-package interconnects

In-memory network and NoCs for new memory technologies

NoC Application

Mapping of applications onto NoCs

NoC case studies, application-specific NoC design NoCs for FPGAs, structured ASICs, CMPs and MPSoCs

NoC designs for heterogeneous systems, fused CPU-GPU architectures, etc

Scalable modeling of NoCs

NoC at the Un-Core and System-level

Design of memory subsystem (un-core) including memory controllers, caches, cache coherence protocols in NoCs

NoC support for memory and cache access

OS support for NoCs

Programming models including shared memory, message passing and novel programming models

Issues related to large-scale systems (datacenters, supercomputers) with NoC-based systems as building blocks

On-Chip Communication Optimization

Communication efficient algorithms

Communication workload characterization & evaluation

Energy efficient NoCs and energy minimization

Off-Chip and Rack-Level Communication

All aspects of inter-chip network design All aspects of rack-level network design

Electronic paper submission requires a full paper, up to 8 double-column IEEE format pages, including figures and references. The program committee in a double-blind review process will evaluate papers based on scientific merit, innovation, relevance, and presentation. Submitted papers must describe original work that has not been published before or is under review by another conference or journal at the same time. Each submission will be checked for any significant similarity to previously published works or for simultaneous submission to other archival venues, and such papers will be rejected. Proposals for special sessions and demos are invited. Paper submissions and demo proposals by industry researchers or engineers to share their experiences and perspectives are also welcome. Please find the detailed submission instructions for paper submissions, special session, and demo proposals at the submission page. Further information is available via:

http://www.arc.ics.keio.ac.jp/nocs17/

Important Dates (extended deadlines)

Abstract registration deadline May 8, 2017 Full paper submission deadline May 15, 2017

Notification of acceptance Final version due July 1, 2017 August 1, 2017

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